VS-GA200HS60S1PbF

Vishay Semiconductors

INT-A-PAK Half Bridge IGBT (Standard Speed IGBT), 200 A



INT-A-PAK

PRIMARY CHARACTERISTICS						
V _{CES} 600 V						
I _C DC	480 A					
V _{CE(on)} at 200 A, 25 °C	1.13 V					
Speed	DC to 1 kHz					
Package	INT-A-PAK					
Circuit configuration	Half bridge					

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FEATURES

- Gen 4 IGBT technology
- · Standard: optimized for hard switching speed
- Very low conduction losses
- Industry standard package
- UL approved file E78996
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Increased operating efficiency
- Direct mounting to heatsink
- · Performance optimized as output inverter stage for TIG welding machines

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	R SYMBOL TEST CONDITI		MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current	1	T _C = 25 °C	480		
Continuous collector current	Ι _C	T _C = 116 °C	200	А	
Pulsed collector current	I _{CM}		800	A	
Peak switching current	I _{LM}		800		
Gate to emitter voltage	V _{GE}		± 20	V	
RMS isolation voltage	VISOL	Any terminal to case, t = 1 min	2500	v	
Maximum power discipation	P _D	T _C = 25 °C	830	W	
Maximum power dissipation		T _C = 85 °C	430	vv	
Operating junction temperature range	TJ		-40 to +150	°C	
Storage temperature range	T _{Stg}		-40 to +125	C	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
Collector to emitter breakdown voltage VBR		$V_{GE} = 0 V, I_C = 1 mA$	600	-	-		
Collector to omitter veltage	V _{CE(on)}	$V_{GE} = 15 \text{ V}, I_{C} = 200 \text{ A}$	-	1.13	1.21	V	
Collector to emitter voltage		V_{GE} = 15 V, I _C = 200 A, T _J = 125 °C	-	1.08	1.18		
Gate threshold voltage	V _{GE(th)}	I _C = 0.25 mA	3	4.5	6		
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 V, V_{CE} = 600 V$	-	0.025	1	mA	
Collector to entitler leakage current		$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	10	ША	
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 250	nA	



COMPLIANT



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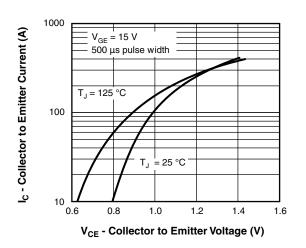


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SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge	Qg	I _C = 200 A	-	1600	1700		
Gate to emitter charge	Q _{ge}	$V_{CC} = 400 \text{ V}$	-	260	340	nC	
Gate to collector charge	Q _{gc}	V _{GE} = 15 V	-	580	670		
Turn-on switching loss	Eon	$I_{C} = 200 \text{ A}, V_{CC} = 480 \text{ V}, V_{GE} = 15 \text{ V}$	-	30	-		
Turn-off switching loss	E _{off}	$R_g = 10 \Omega$	-	50	-	mJ	
Total switching loss	E _{ts}	Freewheeling diode: 30EPH06, T _J = 25 °C	-	80	-		
Turn-on switching loss	Eon	I _C = 200 A, V _{CC} = 480 V, V _{GE} = 15 V	-	34	-		
Turn-off switching loss	E _{off}	$R_{g} = 10 \Omega$	-	104	-	mJ	
Total switching loss	E _{ts}	Freewheeling diode: 30EPH06, T _J = 125 °C	-	138	151		
Input capacitance	Cies	V _{GE} = 0 V	-	32 500	-		
Output capacitance	C _{oes}	$V_{CC} = 30 V$	-	2080	-	pF	
Reverse transfer capacitance	C _{res}	f = 1.0 MHz	-	380	-		

THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS		
Operating junction temperature	TJ	-40	-	150	°C			
Storage temperature range	T _{Stg}	-40	-	125				
Junction to case per leg	R _{thJC}	-	-	0.15	°C/W			
Case to sink		R _{thCS}	-	0.1	-	0/10		
Mounting torque	case to heatsink		-	-	4	Nm		
Mounting torque	case to terminal 1, 2, 3		-	-	3			
Weight			-	185	-	g		





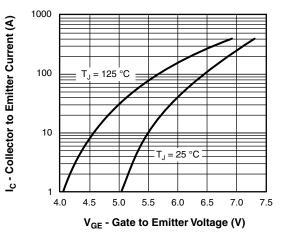


Fig. 2 - Typical Transfer Characteristics



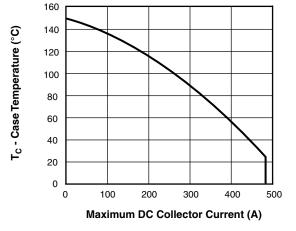


Fig. 3 - Case Temperature vs. Maximum Collector Current

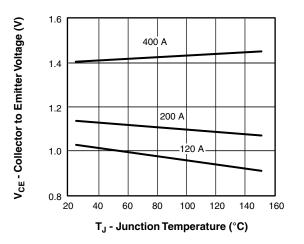


Fig. 4 - Typical Collector to Emitter Voltage vs. Junction Temperature

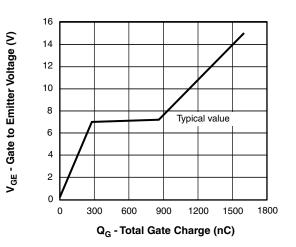


Fig. 5 - Typical Gate Charge vs. Gate to Emitter Voltage

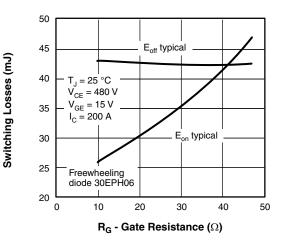
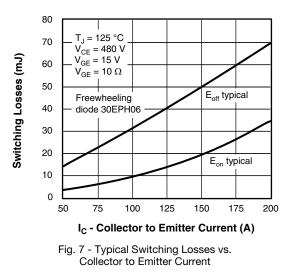
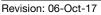


Fig. 6 - Typical Switching Losses vs. Gate Resistance





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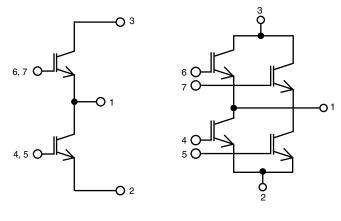
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ORDERING INFORMATION TABLE

Device code	vs-	GA	200	н	S	60	S	1	PbF
	1	2	3	4	5	6	7	8	9
	1 -	Visl	nay Sem	niconduc	ctors pro	duct			
	2 -	- Essential part number IGBT modules							
	3 -	- Current rating (200 = 200 A)							
	4 -	 Circuit configuration (H = half bridge without f/w diode) 							
	5 -	INT-A-PAK							
	6 -	Volt	Voltage code (60 = 600 V)						
	7 -	Spe	Speed/type (S = standard speed IGBT)						
	8 -	Ass	Assy location Italy						
	9 -	Nor	None = standard production; PbF = lead (Pb)-free						

CIRCUIT CONFIGURATION



Functional Diagram

Electrical Diagram

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95173			

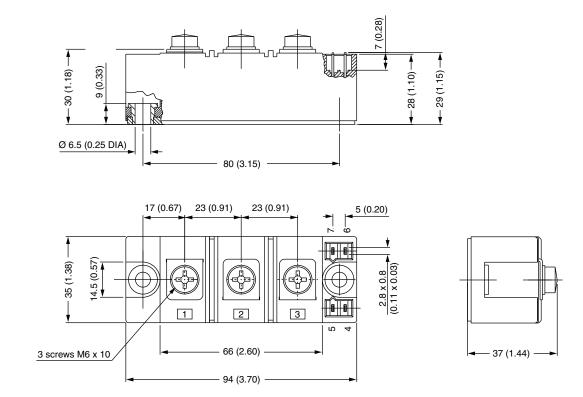


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INT-A-PAK IGBT/Thyristor

DIMENSIONS in millimeters (inches)

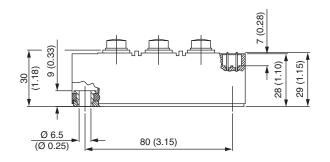


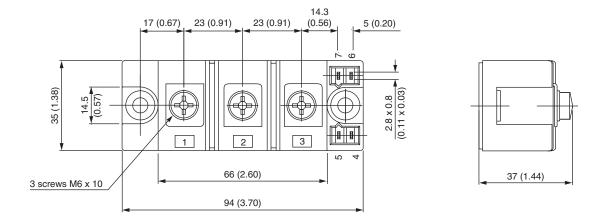




INT-A-PAK IGBT

DIMENSIONS in millimeters (inches)





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